

Tool ID: 421  
Tool Location: 133

## Equipment Information Sheet

# ABM Contact Aligner

**Manager: Garry Bordonaro 607-254-4936**

**Backup: Giovanni Sartorello 607-254-4853**

**Backup: Michael Skvarla 607-254-4674**

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times leave a message or send them an email.

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### SAFETY

- Orange UV glasses are recommended during exposure, but not required

### USAGE RESTRICTIONS

- No buddy system restrictions imposed on normal operation

### SCHEDULING/SIGN-UP RESTRICTIONS

*Minimum Tool Time: 15 minutes*

- Maximum 4 hour block reservations anytime
- Maximum 12 hours reserved in advance
- No consecutive research group reservations
- Users/Groups may use any amount of unreserved time
- Additional individual restrictions may be imposed to maximize use

### MATERIALS COMPATIBILITY CATEGORY

#### Tool Category 5: Class A and B Metals and Compounds

Allowed	Not Allowed
Tool category 1/1E, 2, 3, and 4 materials	
Silicon Based Substrates and Films	
III/V compound Semiconductors	
Glass Substrates	
PECVD and ALD Films	
Cured organics and baked Photoresist	
CNF Class A, B, and Refractory metals	
Exposed Gold, Silver, Copper	
Alkali and Alkaline Compounds	
Organic/Biology Molecules prepared-w/salt buffers	
High Vapor Pressure Materials (Mg, Ca, Zn)*	* Some tool restrictions on high vapor pressure materials may apply
Soft organic materials	

**High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.**

### Additional Material Restrictions and Exceptions

- 4" - 9" masks, up to 200mm wafers, up to 0.25" thick
- Back of substrate must be CLEAN - NO RESIST on back

*Last Updated: 03/05/2026*